19-1097; Rev 0; 6/96 EVALUATION KIT AVAILABLE

Low-Power, 622Mbps Limiting Amplifiers with Chatter-Free Power Detect for LANs

Loss-of-Signal Outputs

4mV Input Sensitivity

Single 5V Power Supply

+ 250ps Output Edge Speed

Low 15ps Pulse-Width Distortion

Loss-of-Signal Interface Logic

tested and guaranteed only at $T_A = +25$ °C.

PECL Data Outputs

PART

MAX3761EEP

MAX3761E/D

MAX3762EEP

MAX3762E/D

Chatter-Free Power Detector with Programmable

Choice of TTL (MAX3761) or PECL (MAX3762)

TEMP. RANGE

-40°C to +85°C

-40°C to +85°C

-40°C to +85°C

-40°C to +85°C

*Dice are designed to operate from -40°C to +85°C, but are

General Description

The MAX3761/MAX3762 limiting amplifiers, with 4mV sensitivity and PECL data outputs, are optimized for operation in low-cost, 622Mbps, LAN ATM fiber optics applications.

An integrated power detector senses the input signal's amplitude. A received-signal-strength indicator (RSSI) gives an analog indication of the power level, while the complementary loss-of-signal (LOS) outputs indicate if the input power level exceeds the programmed threshold level. The LOS threshold can be adjusted to detect signal amplitudes between 3mVp-p and 100mVp-p, providing a 15dB LOS adjustment in fiber optic receivers. The LOS outputs have 3.5dB of hysteresis, which prevents chatter when input signal levels are small. The MAX3761's LOS outputs are compatible with TTL-logic levels. The MAX3762 has PECL LOS outputs.

DISABLE and LOS can be used to implement a squelch function, which turns off the data outputs when the input signal is below the programmed threshold.

Applications

622Mbps LAN/WAN ATM Receivers

155Mbps LAN/WAN ATM Receivers

C7F CA7 +5V TOP VIEW Vcc 150pF ΕN CZN 10nF FII TER DISABLE 20 DISABLE RSSI 19 LOS+ RSSI LOS VCCO LOS EN 18 LOS-100pF CIN BYPASS 5.6nF OUT V_{CC} 17 Vcc 4 **MIXIM** SUPPLY VIN-OUT MAX3761 MAX3762 VIN+ 16 VCCO 500 E C_{IN} M/IXI/M 5.6nF VIN- e 15 OUT+ MAX3761 500 VIN-GNDO GND 14 OUT-1.7 FII TER GND V_{CC} - 2V SUB 8 13 GNDO VTH^{SUB} 100pF Cell ter 12 VTH CZP +Vc CZN 11 INV R1 R2 100k 22k QSOP MAX3762 at end of data sheet.

Pin Configuration

M/XI/M

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Features

Typical Operating Circuits

Ordering Information

PIN-PACKAGE

20 QSOP

20 QSOP

Dice*

Dice'

ABSOLUTE MAXIMUM RATINGS

.....-0.5V to +7.0V V_{CC}, VCCO... $\label{eq:started_st$

Operating Junction Temperature Range40°C to +150°C	
Processing Temperature (die)+400°C	
Storage Temperature Range65°C to +160°C	
Lead Temperature (soldering, 10sec)+300°C	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = +4.5V$ to +5.5V, DISABLE = low, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +5.0V, T_A = +25°C.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply Current	MAX3761, IVCC		25	37	mA
Power-Supply Current	MAX3762, IVCC		30	46	IIIA
LOS Output TTL High	MAX3761	2.8			V
LOS Output TTL Low	MAX3761			0.40	V
LOS Output PECL High	MAX3762 (Notes 2, 3)	-1150		-880	mV
LOS Output PECL Low	MAX3762 (Notes 2, 3)	-1830		-1555	mV
DISABLE Input Current	Logic high			100	μA
DISABLE Input High	MAX3761	2.65			V
DISABLE Input Low	MAX3761			0.8	V
DISABLE Input PECL High	MAX3762 (Note 3)	-1160			mV
DISABLE Input PECL Low	MAX3762 (Note 3)			-1470	mV
PECL Data Output Voltage High (VOH)	(Notes 2, 3)	-1150		-880	mV
PECL Data Output Voltage Low (VOL)	(Notes 2, 3)	-1830		-1555	mV
Disabled Differential Output	DISABLE = high	-100		100	mV
Disabled Common-Mode Output	DISABLE = high	0.7		1.2	V

Note 1: Dice are tested at $T_A = +25^{\circ}C$.

Note 2: Outputs terminated with 50 Ω to V_{CC} - 2V.

Note 3: Voltage measurements are relative to V_{CC}.

AC ELECTRICAL CHARACTERISTICS

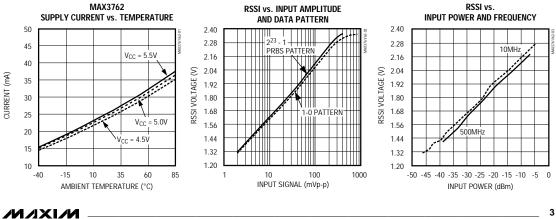
 $(V_{CC} = +4.5V \text{ to } +5.5V, \text{ PECL outputs terminated with } 50\Omega \text{ to } V_{CC} - 2V, \text{ input } 4\text{mV to } 2Vp-p, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +5.0V, T_A = +25^{\circ}\text{C}.)$ (Note 5)

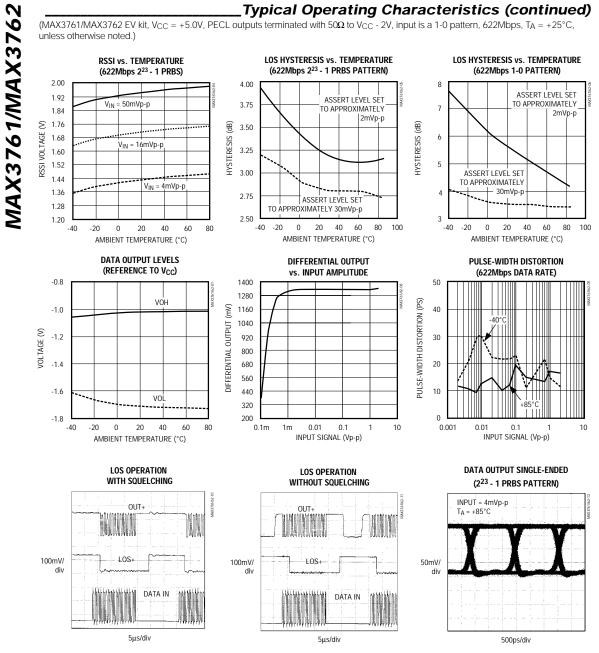
PARAMETER	ETER CONDITIONS		TYP	MAX	UNITS
Minimum LOS Assert Input	T _A = -40°C, 2 ²³ - 1 PRBS			3.2	mV
Data-Output Edge Speed	20% to 80%			250	ps
Data-Output Overshoot	(Note 6)			20	%
Pulse-Width Distortion	(Notes 6, 7)		15	80	ps
Input Resistance	Differential		3900		Ω
LOS Hysteresis	2 ²³ - 1 PRBS, VTH = 1.8V		3.5		dB

Note 5: AC parameters are guaranteed by design and characterization. Note 6: Input signal is a 1-0 pattern, 622Mbps. Note 7: PWD = [(width of wider pulse) - (width of narrower pulse)] / 2.

Typical Operating Characteristics

(MAX3761/MAX3762 EV kit, V_{CC} = +5.0V, PECL outputs terminated with 50Ω to V_{CC} - 2V, input is a 1-0 pattern, 622Mbps, T_A = +25°C, unless otherwise noted.)



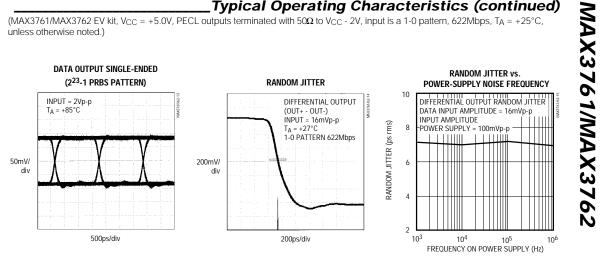


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Typical Operating Characteristics (continued)

(MAX3761/MAX3762 EV kit, V_{CC} = +5.0V, PECL outputs terminated with 50 Ω to V_{CC} - 2V, input is a 1-0 pattern, 622Mbps, T_A = +25°C, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION
1	FILTER	Sets the integration frequency of the power detector. Impedance at this node is approximately 500Ω .
2	RSSI	Received-Signal-Strength Indicator. An analog DC voltage representing the input power.
3	EN	Connect to V _{CC} .
4, 17	Vcc	+5V Power Supply
5	VIN+	Positive Input Data
6	VIN-	Negative Input Data
7	GND	Supply Ground
8	SUB	Substrate. Connect to ground.
9	CZP	Sets input offset correction, low-frequency cutoff.
10	CZN	Sets input offset correction, low-frequency cutoff.
11	INV	Negative Input to Op Amp. Used for programming the loss-of-signal threshold.
12	VTH	Loss-of-Signal Threshold Voltage
13	GNDO	Ground Power Supply for Output Buffers
14	OUT-	Negative PECL Data Output
15	OUT+	Positive PECL Data Output
16	VCCO	+5V Power Supply for Output Buffers
18	LOS-	Negative Loss-of-Power Flag, TTL (MAX3761) or PECL (MAX3762)
19	LOS+	Positive Loss-of-Power Flag, TTL (MAX3761) or PECL (MAX3762)
20	DISABLE	Disables the data outputs when high. TTL (MAX3761) or PECL (MAX3762).



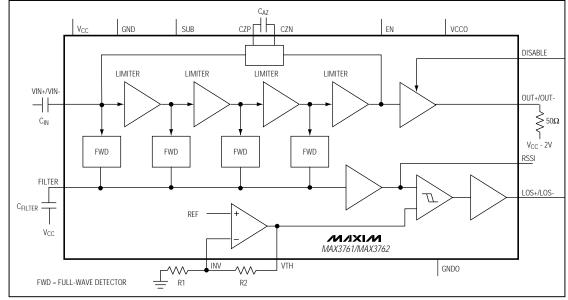


Figure 1. Functional Diagram

Detailed Description

Figure 1 shows the functional diagram for the MAX3761/ MAX3762. The input signal is applied to VIN+ and VIN-. A chain of amplifier stages, each contributing approximately 12.5dB of gain, amplifies the input signal to PECL output voltage swings. A 4mVp-p input signal will cause the output to fully limit.

Received-Signal-Strength Indicator (RSSI)

Each amplifier stage contains a full-wave logarithmic detector (FWD). The full-wave detector outputs are summed at the FILTER pin and used to generate the received-signal-strength indication (RSSI). The RSSI output voltage is linearly proportional to the input power (in decibels), and is approximated by:

 $V_{RSSI}(V) = 1.13 + 0.457 \log(V_{IN})$

where VIN is the peak-to-peak input signal in millivolts.

The RSSI output is insensitive to fluctuations in temperature and supply voltage. The power detector functions as a broadband power meter that detects the total power of all signals present in the passband of approximately 750MHz. Refer to the *Typical Operating Characteristics* graphs showing RSSI output versus input power and signal amplitude. The high-speed RSSI signal is filtered with one external capacitor connected from FILTER to V_{CC}. The impedance at the FILTER pin is approximately 500Ω .

The FILTER capacitor (C_{FILTER}) must be connected to V_{CC} for proper operation.

Input-Offset Correction

The limiting amplifier provides approximately 60dB of gain. An input DC offset of even 1mV reduces the power-detection circuit's accuracy and can cause the output to limit. A low-frequency feedback loop is integrated into the MAX3761/MAX3762 to remove input offset. DC coupling the inputs is not recommended, as this prevents the DC-offset-correction circuitry from functioning properly. Input offset is typically reduced to less than 100µV.

The capacitance between pins CZP and CZN, in parallel with a 10pF integrated capacitance, determines the offset-correction circuit's time constant. The input impedance between CZP and CZN is approximately $800k\Omega$.

The offset correction circuitry requires an average datainput duty cycle of 50%. If the input data has a different average duty cycle, the output will have increased pulse-width distortion.



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Loss-of-Signal Indicator

The MAX3761/MAX3762 includes a loss-of-signal monitor with a programmable assert threshold and a hysteresis comparator. Internally, one comparator input is tied to the RSSI output signal and the other is tied to the threshold-voltage (VTH) pin, which provides a threshold for the LOS indication. An op amp referenced to an internal bandgap voltage (1.18V) is supplied for programming a supply-independent threshold voltage. Only two external resistors are needed to program the LOS assert level. VTH is programmable from 1.18V to 2.4V, providing adequate coverage of the RSSI output's useful range. The op amp runs on very low supply current and provides an accurate, temperature-stable threshold, but can source only 20µA of current. For proper operation, resistor R1 (see the Typical Operating Circuit) should have a value \geq 100k Ω . The input bias current at INV is < 50nA.

To ensure chatter-free LOS operation, the internal LOS comparator contains approximately 90mV of hysteresis. The RSSI signal output has a slope of 25mV/dB. Therefore, the overall circuit hysteresis is approximately 3.6dB[90mV / (25mV/dB)]. The LOS assert threshold is 45mV below V_{TH}, while the LOS deassert threshold is 45mV above V_{TH}.

Output Buffers

The DISABLE pin can be used to disable the dataoutput buffer. When DISABLE is high, the differential output signal at OUT+ and OUT- is approximately zero. In the disabled state, the common-mode voltage of each output is approximately V_{CC} - 0.8V. Connecting

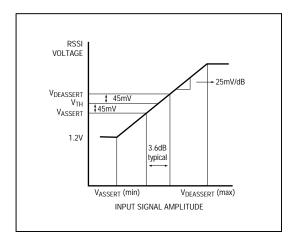


Figure 2. Loss-of-Signal Definitions

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DISABLE to LOS+ implements a squelch function. When using the squelch function, the output signal is disabled whenever the input signal is too small to be reliably detected (as determined by the voltage at VTH). Use of the disable function is recommended at all times.

The data outputs (OUT+ and OUT-) are implemented with emitter followers that have output impedance of approximately 2 Ω . The MAX3762's PECL LOS outputs also are implemented with emitter followers that have output impedance of approximately 2 Ω .

The MAX3761 TTL LOS output buffers are open-collector transistors with $6k\Omega$ internal pull-up resistors.

Design Procedure

Supply Voltage

The MAX3761/MAX3762 can be operated with a single +5V or -5V power supply.

Programming the LOS Assert Level

First determine the receiver system's sensitivity in dBm either by estimating or from prototyping results. Estimate the total gain of the preamplifier and photodiode, then use Figure 3 to select resistor R2, placing the LOS assert 3dB to 4dB below the receiver sensitivity.

Alternatively, use the *Typical Operating Characteristics* to select the V_{TH} value needed for LOS assert, then program V_{TH} with the following relation:

$$V_{TH} = 1.18(1 + R2 / R1)$$

Select R1 \ge 100k Ω .

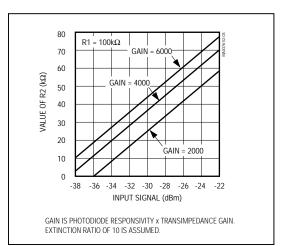


Figure 3. Using TIA Gain and Photodiode Responsivity to Select LOS Programming Resistor

Capacitor Selection

Low-Power, 622Mbps Limiting Amplifiers with Chatter-Free Power Detect for LANs

A typical MAX3761/MAX3762 implementation requires four external capacitors. To select the capacitors, first determine the following parameters in the receiver system (see the *Applications Information* section for recommendations in 622Mbps ATM and Fibre Channel 1063Mbps systems):

 The duration of the expected longest run of consecutive bits in the data stream. For example, 72 consecutive zeros in a 622Mbps data stream have a duration of 116ns.

2) The maximum allowable data-dependent jitter.

- The desired power-detector integration time constant [1/(2πf_{INT})].
- The transimpedance amplifier's maximum peak-topeak output voltage.

Step 1. Select the Input AC-Coupling Capacitors (C_{IN}). When using a limiting preamplifier with a highpass frequency response, select C_{IN} to provide a low-frequency cutoff (f_C) one decade lower than the preamplifier low-frequency cutoff. This causes nearly all data-dependent jitter (DDJ) to be generated in the preamplifier circuit. For example, if the preamplifier's low-frequency cutoff is 150kHz, then select C_{IN} to provide a 15kHz low-frequency cutoff.

Select CIN with the following equation:

$$C_{\rm IN} = \frac{1}{2\pi f_{\rm C} 1950\Omega}$$

For differential input signals, use a capacitor equal to C_{IN} on both inputs (VIN+ and VIN-). For single-ended input signals, one capacitor should be tied to VIN+ and another should decouple VIN- to ground.

When using a preamplifier without a highpass response, select C_{IN} to ensure that data-dependent jitter is acceptable. The following equation provides an estimate for C_{IN} :

$$C_{IN} \ge \frac{-t_L}{1950 \ln \left[1 - \frac{(DDJ)(BW)}{0.5}\right]}$$

where: t_L = duration of the longest run of consecutive bits with the same value (seconds); DDJ = maximum allowable data-dependent jitter, peak-to-peak (seconds); BW = typical system bandwidth, normally 0.6 to 1.0 times the data rate (hertz).

Regardless of which method is used to select C_{IN} , the maximum LOS assert time can be estimated from the

value of C_{IN}. The following equation estimates LOS time delay when the maximum-amplitude signal is instantaneously removed from the input, and when the FILTER time constant is much faster than the input time constant (C_{FILTER} < 0.4C_{IN}):

tLOS ASSERT = 1950CINIn(VMAXp-p / VASSERTp-p)

where V_{MAXp-p} is the maximum output of the preamplifier, and $V_{ASSERTp-p}$ is the input amplitude that causes LOS to assert. The equation describes the input capacitors' discharge time, from maximum input to the LOS threshold into the 1950 Ω , single-ended input resistance.

Step 2. Select the Offset-Correction Capacitor (CAZ).

To maintain stability, it is important to keep a onedecade separation between f_C and the low-frequency cutoff associated with the DC-offset-correction circuit (f_{OC}).

The input impedance between CZP and CZN is approximately 800k Ω in parallel with 10pF. As a result, the low-frequency cutoff (f_OC) associated with the DC-offset-correction loop is computed as follows:

$$f_{OC} = \frac{1}{2\pi 800 k\Omega \left(C_{AZ} + 10 pF\right)}$$

where C_{AZ} is an optional external capacitor between CZP and CZN.

If CIN is known, then:

$$C_{AZ} \ge \frac{C_{IN}}{41} - 10 pF$$

Step 3. Select the Power-Detect Integration Capacitor (CFILTER). For 622Mbps ATM applications, Maxim recommends a filter frequency of 3MHz, which requires CFILTER = 100pF. The integration frequency can be

selected lower to remove low-frequency noise, or to prevent unusual data sequences from asserting LOS. $C_{FILTER} = 1 / (2\pi 500 f_{INT})$

where f_{INT} is the integration frequency.

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Applications Information

Converting Average Optical Power to Signal Amplitude

Many of the MAX3761/MAX3762's specifications relate to input-signal amplitude. When working with fiber optic receivers, the input is usually expressed in terms of average optical power and extinction ratio. The relations given in Table 1 are helpful for converting optical power to input signal when designing with the MAX3761/MAX3762.

Table 1.	Optical-Power	Relations*
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PARAMETER	SYMBOL	RELATION
Average Power	Pave	$P_{AVE} = (P0 + P1)/2$
Extinction Ratio	r _e	r _e = P1 / P0
Optical Power of a "1"	P1	$P1 = 2P_{AVE} \frac{r_e}{r_e + 1}$
Optical Power of a "0"	PO	$P0 = 2P_{AVE} / (r_e + 1)$
Signal Amplitude	Pin	$P_{IN} = P1 - P0 = 2P_{AVE} \frac{(r_e - 1)}{r_e + 1}$

* Assuming a 50% average input data duty cycle (true for SONET/ATM data).

In an optical receiver, the input voltage to the limiting amplifier can be found by multiplying the relationship in Table 1 with the photodiode responsivity (p) and transimpedance amplifier gain (G).

Optical Hysteresis

Power and hysteresis are often expressed in decibels. By definition, decibels are always 10log (power). At the inputs to the MAX3761/MAX3762 limiting amplifier, the power is V_{IN}^2/R . If a receiver's optical input power (x) increases by a factor of two, and the preamplifier is linear, then the voltage input to the MAX3761/MAX3762 also increases by a factor of two.

The optical power change is $10\log(2x/x) = 10\log(2) =$ +3dB

At the MAX3761/MAX3762, the voltage change is:

$$10\log \frac{(2y)^2/R}{y^2/R} = 10\log(2^2) = 20\log(2) = +6dB$$

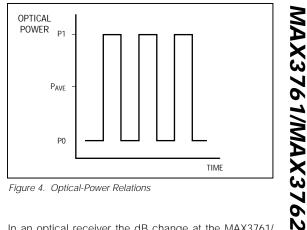


Figure 4. Optical-Power Relations

In an optical receiver the dB change at the MAX3761/ MAX3762 will always equal 2x the optical dB change.

The MAX3761/MAX3762's typical voltage hysteresis is 3.6dB. This provides an optical hysteresis of 1.8dB.

Input Sensitivity

The receiver's gain sensitivity defines the smallest signal input that results in fully limited PECL-compatible data outputs. Smaller signals result in nonlimited outputs. The MAX3761/MAX3762's input sensitivity (SGAIN) is 4mVp-p: SGAIN = 4mV

Optical gain sensitivity (in dBm) is:

$$10\log\left[\frac{S_{GAIN}}{2G\rho} \times \frac{r_{e}+1}{r_{e}-1} \times 1000\right]$$

In a receiver with G = 6k\Omega, r_e = 10, and ρ = 0.8A/W, gain sensitivity is 510nW, or -32.9dBm.

622Mbps ATM Component Selection

As an example, a preamplifier with a 150kHz lowfrequency cutoff and a 950mVp-p maximum output has the best performance with the following selections:

 $C_{IN} = 5.6nF$, so that $f_C = 15kHz$ (one decade below the 150kHz cutoff)

 C_{AZ} = 150pF, so that foc < 1.5kHz (one decade below fc)

 $C_{FILTER} = 100 pF$, so that the integration frequency equals 3MHz.

These selections should provide data-dependent jitter less than 110ps p-p when the input consists of PRBS data with no more than 72 consecutive bits.

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For LOS assert at -35dBm, select R1 = $100k\Omega$ and R2 = $22k\Omega$, which programs the LOS assert at input \cong 3mV. With this selection, LOS assert time will typically be less than 85µs.

Fibre Channel Component Selection In Fibre Channel applications, the desired LOS assert time is typically 25µs maximum, and data-dependent jitter is reduced by 8B10B coding techniques. The following are recommended in a Fibre Channel system where preamp gain is 2000V/W, LOS assert is set for -24dBm (13mV MAX3761/MAX3762 input), and the maximum input to the MAX3761/MAX3762 is 1Vp-p:

 C_{IN} = 3.3nF (to provide LOS assert in 25µs)

 $C_{AZ} = 82 pF$ (to provide $f_{OC} = 1/10 f_C$ for stability)

CFILTER = 100pF (for a 3MHz integration constant)

 $R1 = 100k\Omega$, $R2 = 50k\Omega$ (to set LOS assert at -24dBm)

PECL Terminations

The standard PECL termination (50 Ω to V_{CC} - 2V) is recommended for best performance and output characteristics. The data outputs operate at high speed, and should always drive transmission lines with 50 Ω to 75 Ω terminations. Balanced termination is recommended for all outputs.

Figure 5 shows an alternative method for terminating the data outputs. The technique provides approximately 8mA DC bias current, with a 50 Ω AC load, for the output termination. This technique is useful for viewing the output on an oscilloscope or changing the PECL reference voltage.

The MAX3762's PECL LOS outputs are relatively slow and do not need 50Ω terminations (although they are capable of driving them). To reduce power, the MAX3762's LOS outputs can be terminated with 500Ω . Figure 6 shows a typical operating circuit for the MAX3762.

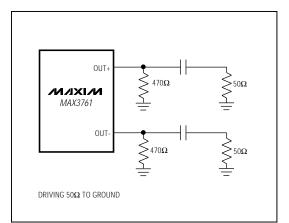


Figure 5. Alternative PECL Termination

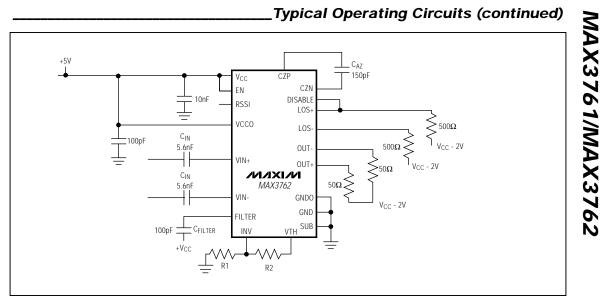
Wire Bonding

For high current density and reliable operation, the MAX3761/MAX3762 use gold metalization. Make connections to the dice with gold wire only, and use ballbonding techniques (wedge bonding is not recommended). Die-pad size is 4 mils square, with a 6 mil pitch. Die thickness is 12 mils (0.3mm).

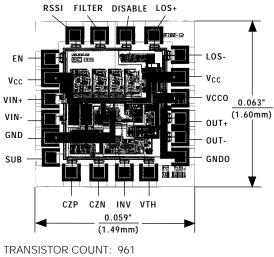
Layout Techniques

The MAX3761/MAX3762 are high-frequency, highbandwidth circuits. To ensure stability, use good highfrequency layout techniques. Filter voltage supplies, and keep ground connections short. Use multiple vias where possible. Use controlled-impedance transmission lines to connect the MAX3761/MAX3762 data outputs to other circuits.

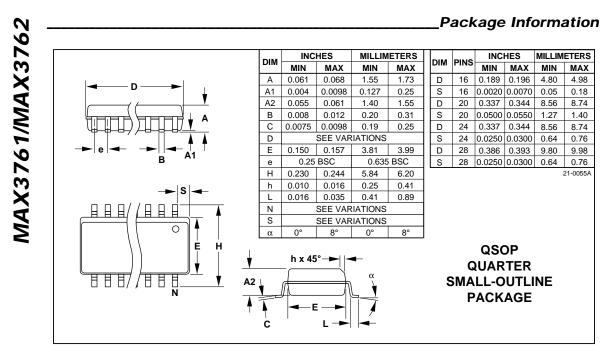
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Chip Topography



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